	Docket No.: KCL-0005
FORM PTO-1595 (Modified) (Rev. 03-01) OMB No. 0651-0027 (exp.5/31/2002)	HEET U.S. DEPARTMENT OF COMMERCE
OMB No. 0651-0027 (exp.5/31/2002) POBA/REV03 Tab settings → ▶ ▼	Patent and Trademark Office
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To the Director of the United States Patern 1.03068966	
1. Name of conveying party(ies): Sung Pil YOON, Seong Ahn HONG, In Hwan OH, Tae Hoon LIM, Suk-Woo NAM, Heung Yong HA, Jonghee HAN, Eun Ae CHO, Jaeyoung LEE	Name and address of receiving party(ies): Name: Korea Institute of Science and Technology Address: 39-1, Hawolgok-dong, Seongbuk-gu
Additional names(s) of conveying party(ies)	
3. Nature of conveyance:	
☑ Assignment	
☐ Security Agreement ☐ Change of Name	City: Seoul State/Prov.:
☐ Other	Country: Republic of Korea ZIP:
Execution Date: July 6, 2005	Additional name(s) & address(es)
6/25/2005 PRYRHE 00000102 061130 11208175 1 FC:8021 40.00 BA	☐ Yes ☒ No
5. Name and address of party to whom correspondence	6. Total number of applications and patents involved:
concerning document should be mailed:	
Name: Jae Y. PARK	7. Total fee (37 CFR 3.41):\$ 40.00
Registration No. Ltd. Recognition No. L0077 Address: Cantor Colburn LLP	 Enclosed - Any excess or insufficiency should be credited or debited to deposit account
55 Griffin Road South	Authorized to be charged to deposit account
	8. Deposit account number:
City: Bloomfield State/Prov.: CT	06-1130
Country: USA ZIP: 06002	(Attach duplicate copy of this page if paying by deposit account)
9. Statement and signature.	USE THIS SPACE
9. Statement and signature. To the best of my knowledge and belief, the foregoing information of the original document.	tion is true and correct and any attached copy is a true copy
Jae Y. PARK	August 19, 2005
Name of Person Signing Total number of pages including cover	Signature Date

ASSIGNMENT

WHEREAS We, Sung Pil YOON of 1011-1402, Samsung-apartment, Imae-dong, Bundang-gu, Seongnam-si, Gyeonggi-do, Republic of Korea, Seong Ahn HONG of 102-1301, Cheonggu-apartment, 78-4, Samsung-dong, Gangnam-gu, Seoul, Republic of Korea, In Hwan OH of 101-803, Sinandongjin-apartment, Junggyebon-dong, Nowon-gu, Seoul, Republic of Korea, Tae Hoon LIM of 220-603, Family-apartment, 150, Munjeong-dong, Songpa-gu, Seoul, Republic of Korea, Suk-Woo NAM of 6-1506, Sinhyundai-apartment, Hoegi-dong, Dongdaemun-gu, Seoul, Republic of Korea, Heung Yong HA of 202-1408, Hyundai 2-cha-apartment, Sanggye-dong, Nowon-gu, Seoul, Republic of Korea, Jonghee HAN of 330-213, Seongbuk-dong, Seongbuk-gu, Seoul, Republic of Korea, Eun Ae CHO of 105-203, Daewoo-apartment, Jeongneung-dong, Seongbuk-gu, Seoul, Republic of Korea, and Jaeyoung LEE of 108-2202, Daewoo-apartment, Cheongcheon-dong, Bupyeong-gu, Incheon, Republic of Korea (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in:

REINFORCED MATRIX FOR MOLTEN CARBONATE FUEL CELL USING PORO US ALUMINUM SUPPORT AND METHOD FOR PREPARING THE MOLTEN CAR BONATE FUEL CELL COMPRISING THE REINFORCED MATRIX

which claims priority to Korean Patent Application No. <u>10-2005-0020973</u>, filed on <u>March 14</u>, <u>2005</u>, and for which We are about to file an application for Letters Patent of the United States;

AND WHEREAS, Korea Institute of Science and Technology (hereinafter referred to as "ASSIGNEE"), a legal entity organized and existing under the laws of the Country of Republic of Korea, having a place of business at 39-1, Hawolgok-dong, Seongbuk-gu, Seoul, Republic of Korea, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said

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ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: July 6. 2005

Sung Pil YOON L.S.

Date: July 6, 2005

Date: July 6, 2005

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Date: Tuly 6, 2005	Tae Hoon LIM L.S.
Date: July 6', 2005	Suk-Woo NAM
Date: July 6, 2005	Heung Yong HA L.S.
Date: July, 6. 2005	Jorghee HAN
Date: July 6. 2005	Eun Ae CHO L.S.
Date: July 6, 2005	Jaeyoung LEE L.S.

RECORDED: 08/19/2005